

## SSCU9N60GN6

#### **N-Channel Enhancement Mode Power MOSFET**

#### Features

#### **N-Channel**

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	l <sub>D</sub>
60V	±20V	8.9mΩ@10V	50A
		10.9mΩ@4V5	30/1

## Description

The SSCU9N60GN6 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

100% UIS + ΔVDS + Rg Tested!

### Applications

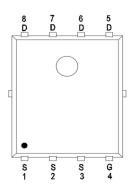
- PWM Applications
- Load Switch
- DC-DC Converters
- Wireless Chargers

#### Ordering Information

Device	Package	Shipping
SSCU9N60GN6	PDFN5X6	5000/Reel

## Pin configuration

Top view





PDFN5X6



Marking

(XXYY: Internal Traceability Code)



## ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage		60	V
V <sub>GSS</sub>	Gate-to-Source Voltage		±20	V
	0 11 5 10 11	T <sub>C</sub> =25℃	50	^
l <sub>D</sub>	Continuous Drain Current d	Tc=100°C	31	A
	Continuous Drain Current a	T <sub>A</sub> =25°C	18	
IDSM		T <sub>A</sub> =70°C	12.8	_ A
I <sub>DM</sub>	Pulsed Drain Current <sup>b</sup>		200	А
Ъ	Power Dissipation <sup>c</sup>	Tc=25℃	57	14/
P <sub>D</sub>		Tc=100°C	20	W
D	Power Dissipation <sup>a</sup>	T <sub>A</sub> =25°C	4.5	10/
P <sub>DSM</sub>		T <sub>A</sub> =70°C	2.9	W
I <sub>AS</sub>	Avalanche Current b L=0.5mH Single Pulse		26	А
Eas	Avalanche Energy b L=0.5mH Single Pulse		169	mJ
TJ	Operation junction temperature		-55~150	- °C
T <sub>STG</sub>	Storage temperature	-55~150		

## ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Max.	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance a	28	36	°C AA/
R <sub>0</sub> JC	Junction-to-Case Thermal Resistance	2.5	3.3	°C/W

#### Note:

- a. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper,in a still air environment with T<sub>A</sub>=25 °C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

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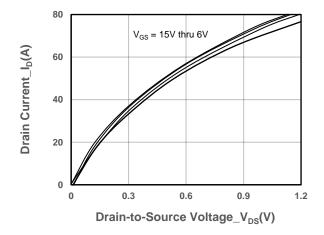
# SSCU9N60GN6

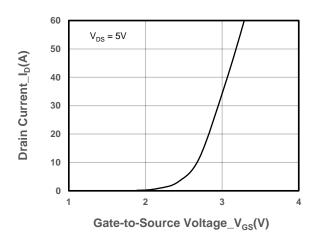
## ➤ N-Channel Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA	60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250uA$	1.0	-	2.5	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		8.9	10.8	mΩ
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 15A		10.9	14.5	mΩ
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V			1	uA
Gate-Source Leak Current	Igss	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A			0.99	V
Gate Resistance	R <sub>G</sub>	$V_{DS} = 0V, f = 1MHz$		1.4		Ω
Input Capacitance	C <sub>ISS</sub>	V 20V V 0V		2411		
Output Capacitance	Coss	$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$		124		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	T = TIVITZ		116		
Total Gate Charge	Q <sub>G</sub>	V 40V V 20V		13.9		
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> =30V,		1.6		nC
Gate to Drain Charge	Q <sub>GD</sub>	$I_D = 20A$		3.1		
Turn-on Delay Time	T <sub>D(ON)</sub>			4.3		
Rise Time	Tr	$V_{GS} = 10V, V_{DS} = 30V,$		16		
Turn-off Delay Time	$T_{D(OFF)}$	$R_L=1.5\Omega,R_G=6\Omega$		6.5		ns
Fall Time	Tf			24		
Diode Recovery Time	Trr	I <sub>F</sub> =20A, di/dt=100A/us		24		ns
Diode Recovery Charge	Qrr	I <sub>F</sub> =20A, di/dt=100A/us		9.3		nC



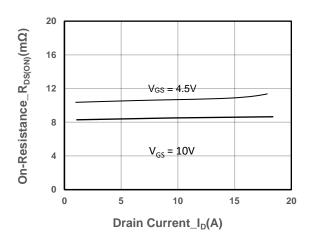
### ➤ N-Channel Typical Performance Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

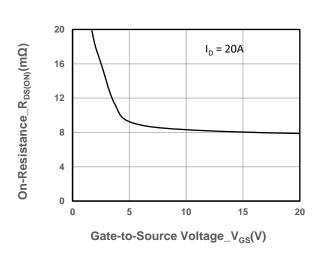




#### **Output Characteristics**

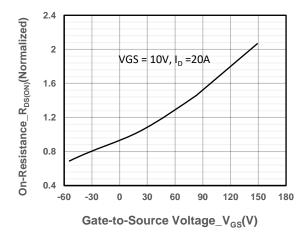
**Transfer Characteristics** 

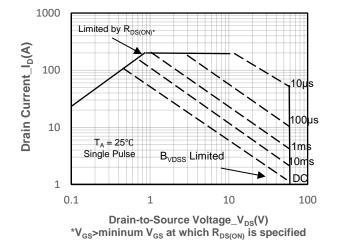




#### On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



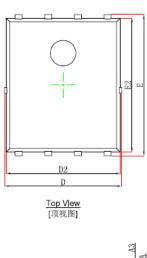


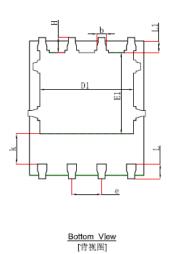
**On-Resistance vs. Junction Temperature** 

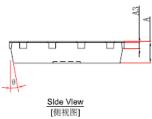
Safe Operating Area vs. Junction-to-Ambient



## > Package Information







Package: PDNF5X6-8L

Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	1REF	0.010	REF	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270TYP		0.050TYP		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	10°	12°	10°	12°	



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